

# DATA SHEET

## **74LVT2244**

**3.3V Octal buffer/line driver with  $30\Omega$  series termination resistors (3-State)**

Product specification  
Supersedes data of 1996 Aug 28  
IC23 Data Handbook

1998 Feb 19

# 3.3V Octal buffer/line driver with 30Ω series termination resistors (3-State)

## 74LVT2244

### FEATURES

- Octal bus interface
- 3-State buffers
- Output capability: +12mA/-12mA
- TTL input and output switching levels
- Input and output interface capability to systems at 5V supply
- Bus-hold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Power-up 3-State
- Live insertion/extraction permitted
- No bus current loading when output is tied to 5V bus
- Latch-up protection exceeds 500mA per JEDEC Std 17
- ESD protection exceeds 2000V per MIL STD 883 Method 3015 and 200V per Machine Model
- Outputs include series resistance of 30Ω, making external termination resistors unnecessary.

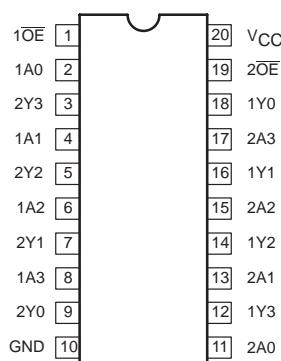
### QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS $T_{amb} = 25^\circ\text{C}$ ; GND = 0V	TYPICAL	UNIT
$t_{PLH}$ $t_{PHL}$	Propagation delay nAx to nYx	$C_L = 50\text{pF}$ ; $V_{CC} = 3.3\text{V}$	2.9 2.9	ns
$C_{IN}$	Input capacitance	$V_I = 0\text{V}$ or $3.0\text{V}$	4	pF
$C_{OUT}$	Output capacitance	Outputs disabled; $V_O = 0\text{V}$ or $3.0\text{V}$	7	pF
$I_{CCZ}$	Total supply current	Outputs disabled; $V_{CC} = 3.6\text{V}$	0.13	mA

### ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
20-Pin Plastic SOL	-40°C to +85°C	74LVT2244 D	74LVT2244 D	SOT163-1
20-Pin Plastic SSOP Type II	-40°C to +85°C	74LVT2244 DB	74LVT2244 DB	SOT339-1
20-Pin Plastic TSSOP Type I	-40°C to +85°C	74LVT2244 PW	7LVT2244PW DH	SOT360-1

### PIN CONFIGURATION



SV00010

### DESCRIPTION

The LVT2244 is a high-performance BiCMOS product designed for V<sub>CC</sub> operation at 3.3V.

This device is an octal buffer that is ideal for driving bus lines. The device features two Output Enables ( $\overline{OE}_1$ ,  $\overline{OE}_2$ ), each controlling four of the 3-State outputs.

The 74LVT2244 is designed with 30Ω series resistance in both the High and Low states of the output. This design reduces the line noise in applications such as memory address drivers, clock drivers and bus receivers/transmitters.

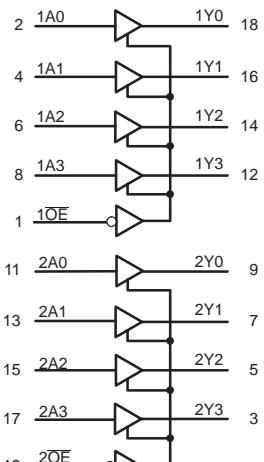
### PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
2, 4, 6, 8	1A0 – 1A3	Data inputs
11, 13, 15, 17	2A0 – 2A3	Data inputs
18, 16, 14, 12	1Y0 – 1Y3	Data outputs
9, 7, 5, 3	2Y0 – 2Y3	Data outputs
1, 19	$\overline{OE}_1$ , $\overline{OE}_2$	Output enables
10	GND	Ground (0V)
20	V <sub>CC</sub>	Positive supply voltage

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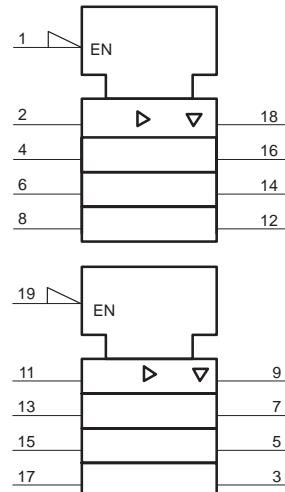
74LVT2244

## LOGIC SYMBOL



SV00011

## LOGIC SYMBOL (IEEE/IEC)



SV00012

## FUNCTION TABLE

INPUTS		OUTPUTS
$\overline{nOE1}$	$nAx$	$nYx$
L	L	L
L	H	H
H	X	Z

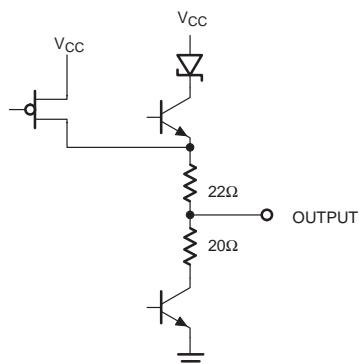
H = High voltage level

H = High voltage level  
L = Low voltage level

L = Low voltage  
X = Don't care

X = Don't care  
Z = High impedance "off" state

## SCHEMATIC OF EACH OUTPUT



SW00303

## ABSOLUTE MAXIMUM RATINGS<sup>1, 2</sup>

Symbol	Parameter	Conditions	Rating	Unit
$V_{CC}$	DC supply voltage		-0.5 to +4.6	V
$V_I$	DC input voltage <sup>3</sup>		-0.5 to +7.0	V
$V_{OUT}$	DC output voltage <sup>3</sup>	Output in Off or High state	-0.5 to +7.0	V
$I_{OUT}$	DC output current	Output in Low state	128	mA
		Output in High state	-64	
$I_{IK}$	DC input diode current	$V_I < 0$	-50	mA
$I_{OK}$	DC output diode current	$V_O < 0$	-50	mA
$T_{sta}$	Storage temperature range		-65 to 150	°C

## NOTES:

**NOTES:**

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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## RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS		UNIT
		MIN	MAX	
$V_{CC}$	DC supply voltage	2.7	3.6	V
$V_I$	Input voltage	0	5.5	V
$V_{IH}$	High-level input voltage	2.0		V
$V_{IL}$	Low-level Input voltage		0.8	V
$I_{OH}$	High-level output current		-12	mA
$I_{OL}$	Low-level output current		12	mA
$\Delta t/\Delta v$	Input transition rise or fall rate; outputs enabled		10	ns/V
$T_{amb}$	Operating free-air temperature range	-40	+85	°C

## DC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT	
			$T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$				
			MIN	TYP <sup>1</sup>	MAX		
$V_{IK}$	Input clamp voltage	$V_{CC} = 2.7\text{V}$ ; $I_I = -18\text{mA}$		0.9	-1.2	V	
$V_{OH}$	High-level output voltage	$V_{CC} = 3\text{V}$ ; $I_{OH} = -12\text{mA}$	2	2.5		V	
$V_{OL}$	Low-level output voltage	$V_{CC} = 3\text{V}$ ; $I_{OL} = 12\text{mA}$			0.8	V	
$I_I$	Input leakage current	$V_{CC} = 0$ or $3.6\text{V}$ ; $V_I = 5.5\text{V}$		1	10	$\mu\text{A}$	
		$V_{CC} = 3.6\text{V}$ ; $V_I = V_{CC}$ or GND	Control pins	$\pm 0.1$	$\pm 1$		
		$V_{CC} = 3.6\text{V}$ ; $V_I = V_{CC}$	Data pins <sup>4</sup>	0.1	1		
		$V_{CC} = 3.6\text{V}$ ; $V_I = 0$		-1	-5		
$I_{OFF}$	Output off current	$V_{CC} = 0\text{V}$ ; $V_I$ or $V_O = 0$ to $4.5\text{V}$		1	$\pm 100$	$\mu\text{A}$	
$I_{HOLD}$	Bus Hold current A inputs <sup>6</sup>	$V_{CC} = 3\text{V}$ ; $V_I = 0.8\text{V}$	75	150		$\mu\text{A}$	
		$V_{CC} = 3\text{V}$ ; $V_I = 2.0\text{V}$	-75	-150			
		$V_{CC} = 0\text{V}$ to $3.6\text{V}$ ; $V_{CC} = 3.6\text{V}$	$\pm 500$				
$I_{EX}$	Current into an output in the High state when $V_O > V_{CC}$	$V_O = 5.5\text{V}$ ; $V_{CC} = 3.0\text{V}$		60	125	$\mu\text{A}$	
$I_{PU/PD}$	Power up/down 3-State output current <sup>3</sup>	$V_{CC} = \leq 1.2\text{V}$ ; $V_O = 0.5\text{V}$ to $V_{CC}$ ; $V_I = \text{GND}$ or $V_{CC}$ ; OE/OE = Don't care		$\pm 1$	$\pm 100$	$\mu\text{A}$	
$I_{OZH}$	3-State output High current	$V_{CC} = 3.6\text{V}$ ; $V_O = 3.0\text{V}$		1	5	$\mu\text{A}$	
$I_{OZL}$	3-State output Low current	$V_{CC} = 3.6\text{V}$ ; $V_O = 0.5\text{V}$		-1	-5	$\mu\text{A}$	
$I_{CCH}$	Quiescent supply current	$V_{CC} = 3.6\text{V}$ ; Outputs High, $V_I = \text{GND}$ or $V_{CC}$ , $I_O = 0$		0.12	0.19	$\text{mA}$	
$I_{CCL}$		$V_{CC} = 3.6\text{V}$ ; Outputs Low, $V_I = \text{GND}$ or $V_{CC}$ , $I_O = 0$		3	12		
$I_{CCZ}$		$V_{CC} = 3.6\text{V}$ ; Outputs Disabled; $V_I = \text{GND}$ or $V_{CC}$ , $I_O = 0^5$		0.12	0.19		
$\Delta I_{CC}$	Additional supply current per input pin <sup>2</sup>	$V_{CC} = 3.0$ to $3.6\text{V}$ ; One input at $V_{CC} - 0.6\text{V}$ ; Other inputs at $V_{CC}$ or GND		0.1	0.2	$\text{mA}$	

## NOTES:

1. All typical values are at  $T_{amb} = 25^{\circ}\text{C}$ .
2. This is the increase in supply current for each input at  $V_{CC} - 0.6\text{V}$ .
3. This parameter is valid for any  $V_{CC}$  between  $0\text{V}$  and  $1.2\text{V}$  with a transition time of up to  $10\text{msec}$ . From  $V_{CC} = 1.2\text{V}$  to  $V_{CC} = 3.3\text{V} \pm 10\%$  a transition time of  $100\mu\text{sec}$  is permitted. This parameter is valid for  $T_{amb} = 25^{\circ}\text{C}$  only.
4. Unused pins at  $V_{CC}$  or GND
5.  $I_{CCZ}$  is measured with outputs pulled to  $V_{CC}$  or GND.
6. This is the bus hold overdrive current required to force the input to the opposite logic state.

# 3.3V Octal buffer/line driver with $30\Omega$ series termination resistors (3-State)

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## AC CHARACTERISTICS

$V_{CC} = 0V$ ;  $t_R = t_F = 2.5\text{ns}$ ;  $C_L = 50\text{pF}$ ;  $R_L = 500\Omega$ ;  $T_{amb} = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ .

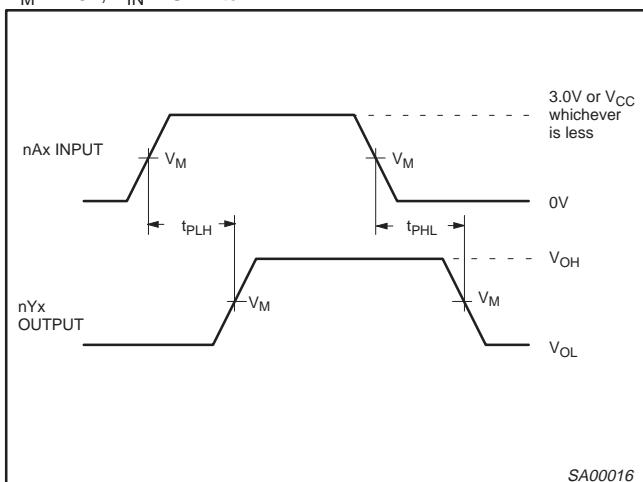
SYMBOL	PARAMETER	WAVEFORM	LIMITS				UNIT	
			$V_{CC} = 3.3V \pm 0.3V$		$V_{CC} = 2.7V$			
			MIN	TYP <sup>1</sup>	MAX	MAX		
$t_{PLH}$ $t_{PHL}$	Propagation delay nAx to nYx	1	1 1	2.9 2.9	4.4 4.1	5.3 4.4	ns	
$t_{PZH}$ $t_{PZL}$	Output enable time to High and Low level	2	1 1.1	3.7 3.7	5.9 5.5	7.7 6.2	ns	
$t_{PHZ}$ $t_{PLZ}$	Output disable time from High and Low level	2	1.9 1.8	4.3 3.3	6.1 4.5	6.8 4.5	ns	

### NOTE:

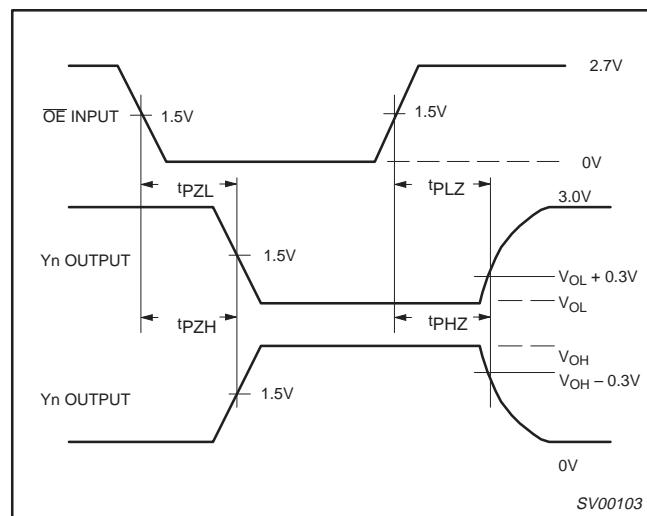
1. All typical values are at  $V_{CC} = 3.3V$  and  $T_{amb} = 25^\circ\text{C}$ .

## AC WAVEFORMS

$V_M = 1.5V$ ,  $V_{IN} = \text{GND}$  to  $2.7V$



Waveform 1. Input (nAx) to Output (nYx) Propagation Delays

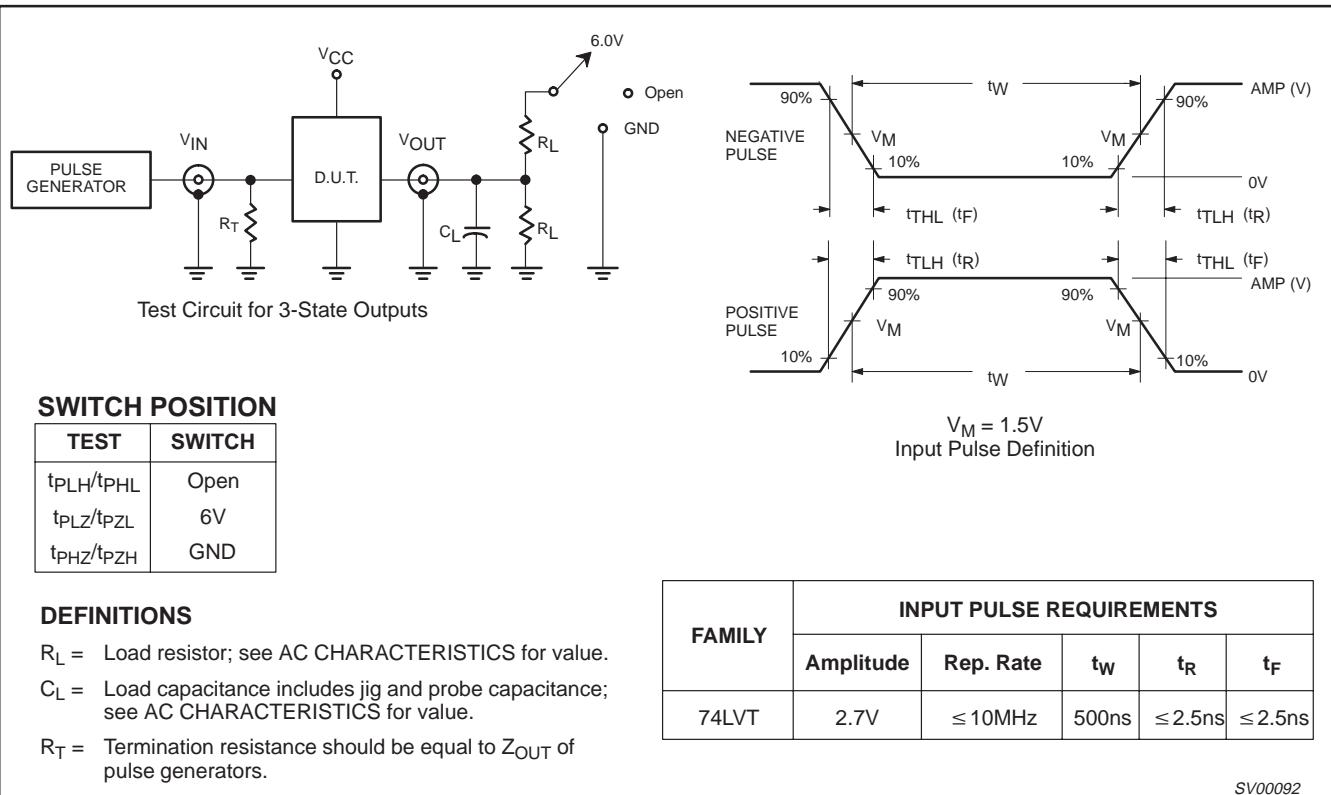


Waveform 2. 3-State Output Enable and Disable Times

# 3.3V Octal buffer/line driver with $30\Omega$ series termination resistors (3-State)

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## TEST CIRCUIT AND WAVEFORMS

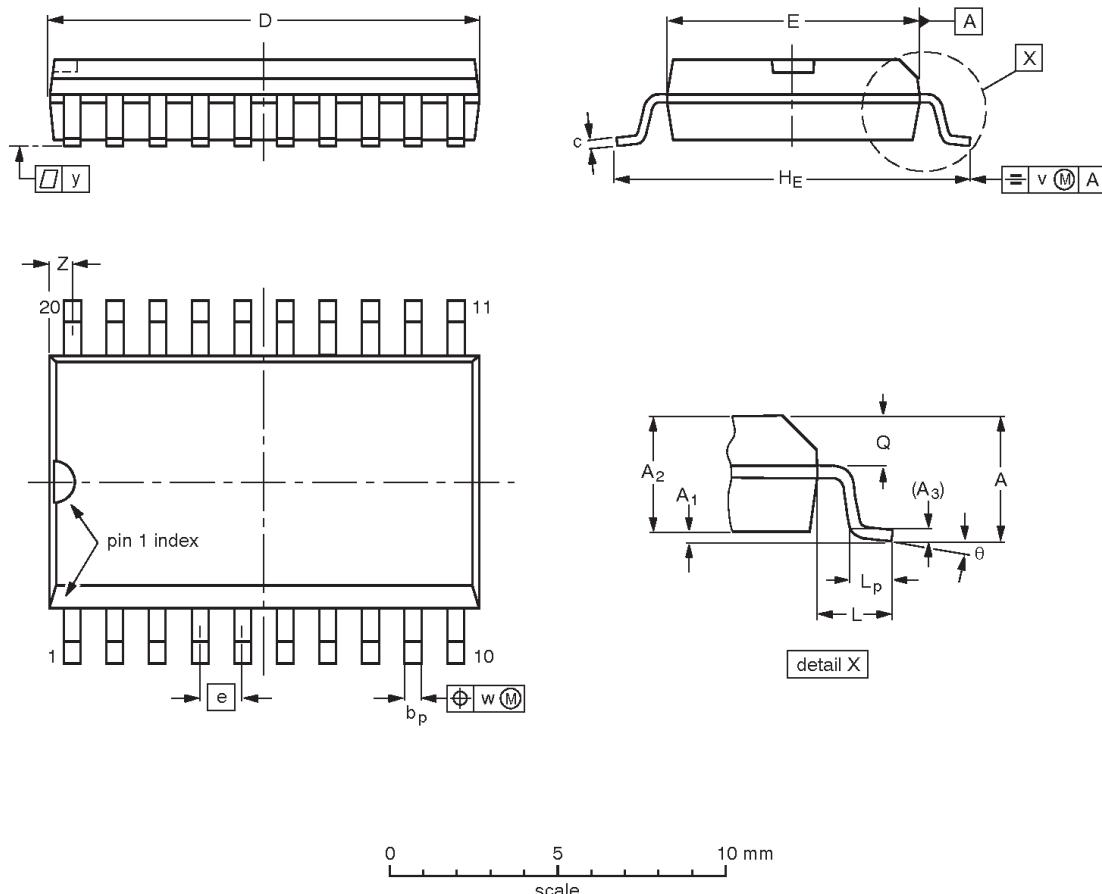


## 3.3V Octal buffer/line driver with 30Ω series termination resistors (3-State)

74LVT2244

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



## DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	2.65 0.10	0.30 2.25	2.45	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8° 0°
inches	0.10 0.004	0.012 0.089	0.096	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.42 0.39	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	

## Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

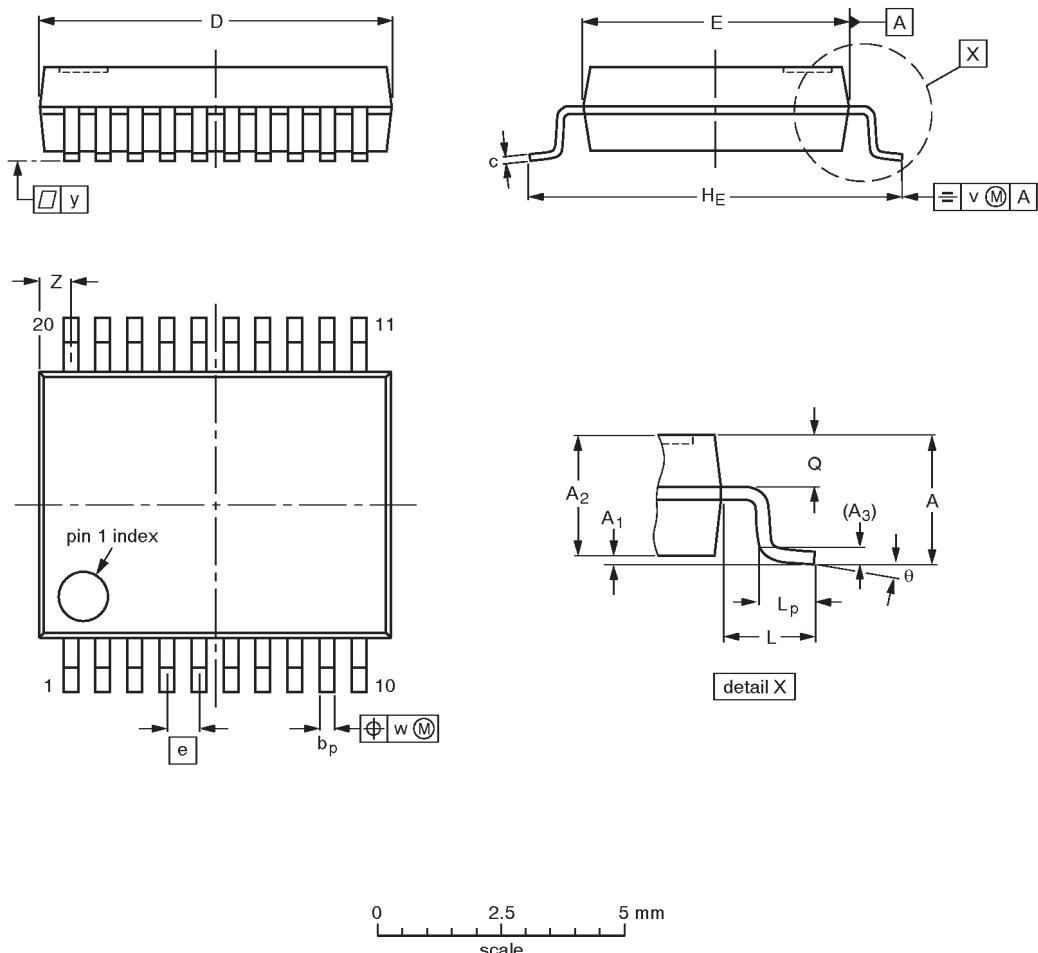
OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ		
SOT163-1	075E04	MS-013AC			92-11-17 95-01-24

## 3.3V Octal buffer/line driver with 30Ω series termination resistors (3-State)

74LVT2244

SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



## DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	2.0 0.05	0.21 1.65	1.80	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

## Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

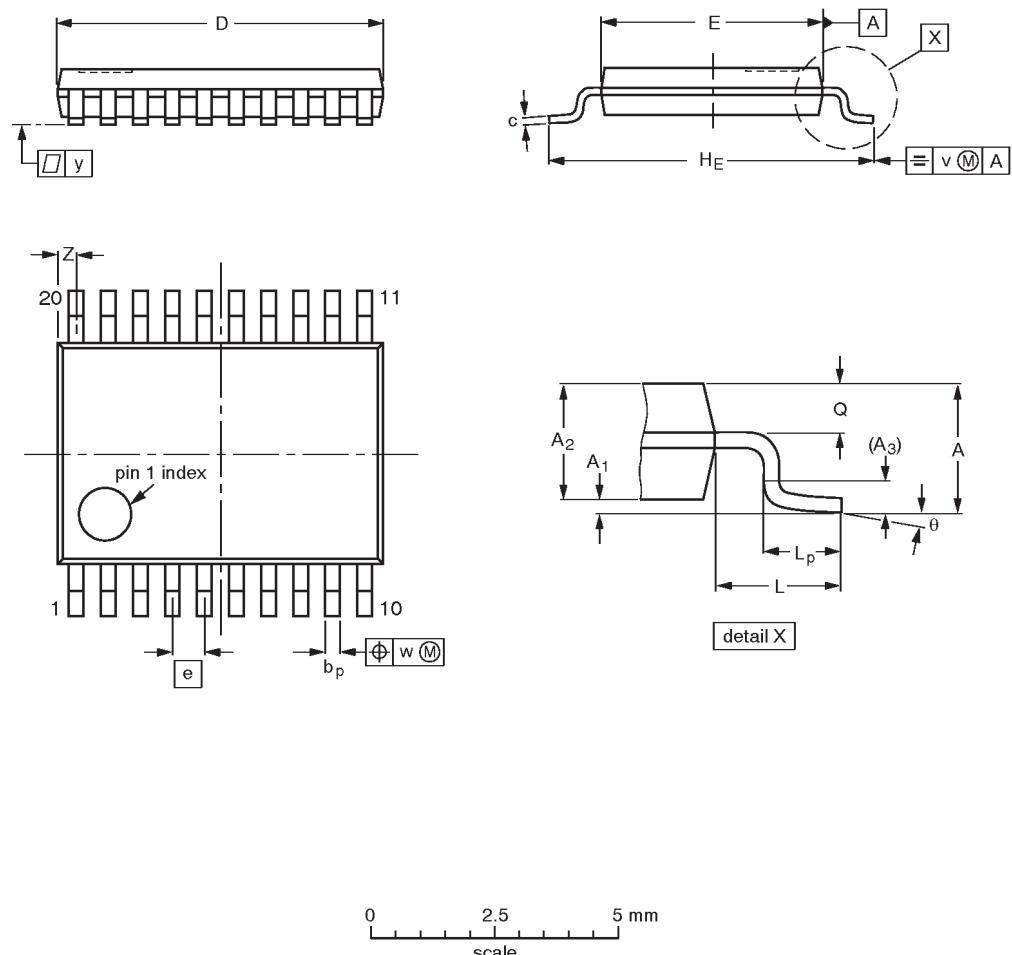
OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ		
SOT339-1		MO-150AE			93-09-08 95-02-04

## 3.3V Octal buffer/line driver with 30Ω series termination resistors (3-State)

74LVT2244

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



## DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(2)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	z <sup>(1)</sup>	θ
mm	1.10 0.05	0.15 0.080	0.95	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

## Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT360-1		MO-153AC				-93-06-16 95-02-04

# 3.3V Octal buffer/line driver with 30Ω series termination resistors (3-State)

74LVT2244

## Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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